UNR8231/8231A (UN8231/8231A)

Silicon NPN epitaxial planar type

For switching

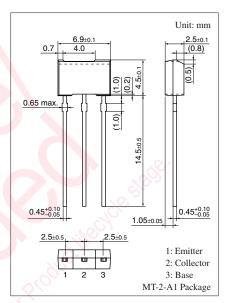
■ Features

- High forward current transfer ratio h_{FE}
- Resistor built-in type, allowing downsizing of the equipment and reduction of the number of parts
- Available in a type with radial taping

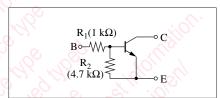
■ Absolute Maximum Ratings $T_a = 25$ °C

Paramete	Symbol	Rating	Unit		
Collector-base voltage	UNR8231	V_{CBO}	20	V	
(Emitter open)	UNR8231A		60		
Collector-emitter	UNR8231	V _{CEO}	20	V	
voltage (Base open)	UNR8231A		50		
Collector current	I_{C}	0.7	A		
Peak collector current	I _{CP}	1.5	A		
Total power dissipation	P _T	1	W		
Junction temperature	T _j	150	°CO		
Storage temperature	T _{stg}	-55 to +150	°C		

Note) *: Printed circuit board: Copper foil area of 1 cm² or more, and the board thickness of 1.7 mm for the collector portion



Internal Connection



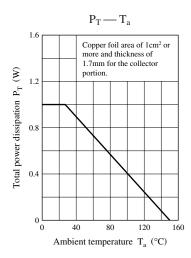
■ Electrical Characteristics $T_a = 25$ °C ± 3 °C

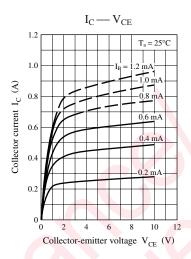
Parameter		Symbol	Conditions	Min	Тур	Max	Unit
Collector-base voltage	UNR8231	V_{CBO}	$I_C = 10 \mu A, I_E = 0$	20			V
(Emitter open)	UNR8231A	5	9/31 9/3 00 00	60			
Collector-emitter	UNR8231	V _{CEO}	$I_{\rm C} = 1 \text{ mA}, I_{\rm B} = 0$	20			V
voltage (Base open)	UNR8231A			50			
Collector-base cutoff curren	nt (Emitter open)	I_{CBO}	$V_{CB} = 15 \text{ V}, I_E = 0$			1	μΑ
Collector-emitter cutoff cur	rent (Base open)	I_{CEO}	$V_{CE} = 15 \text{ V}, I_{B} = 0$			10	μΑ
Emitter-base cutoff current	(Collector open)	I _{EBO}	$V_{EB} = 14 \text{ V}, I_{C} = 0$			0.5	mA
Forward current transfe	er ratio *	h_{FE}	$V_{CE} = 10 \text{ V}, I_{C} = 150 \text{ mA}$	800		2100	_
Collector-emitter saturat	ion voltage *	V _{CE(sat)}	$I_C = 500 \text{ mA}, I_B = 5 \text{ mA}$			0.4	V
Input resistance		R_1		0.7	1.0	1.3	kΩ
Resistance ratio		R ₁ /R ₂		0.016	0.021	0.025	_
Transition frequency		f_T	$V_{CB} = 10 \text{ V}, I_{E} = -50 \text{ mA}, f = 200 \text{ MHz}$		200		MHz

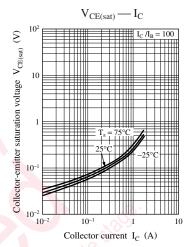
Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

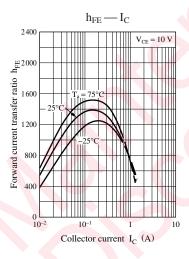
2. *: Pulse measurement

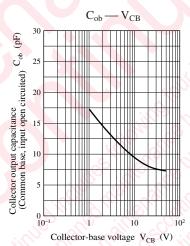
Note) The part numbers in the parenthesis show conventional part number.











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